## INTEGRATED CIRCUITS

## DATA SHEET

# **74ALS240A/74ALS240A–1**Octal inverter buffer (3–State)

Product specification IC05 Data Handbook





74ALS240A/ 74ALS240A-1

#### **FEATURES**

- Octal bus interface
- 3-State buffer outputs sink 24mA and source 15mA
- The -1 version sinks 48 mA

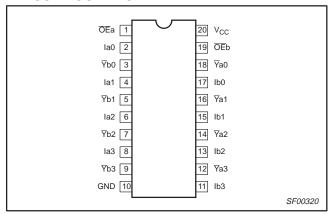
#### **DESCRIPTION**

The 74ALS240A is an octal buffer that is ideal for driving bus lines or buffer memory address registers. The outputs are all capable of sinking 24mA and sourcing up to 15mA, producing very good capacitive drive characteristics. The device features two output enables,  $\overline{\text{OE}}$ a and  $\overline{\text{OE}}$ b, each controlling four of the 3-State outputs.

The 74ALS240A-1 sinks 48 mA  $I_{OL}$  if the  $V_{CC}$  is limited to 5.0V  $\pm 0.25 V.$ 

TYPE	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74ALS240A	4.5ns	15mA
74ALS240A-1	4.5ns	15mA

#### **PIN CONFIGURATION**



#### ORDERING INFORMATION

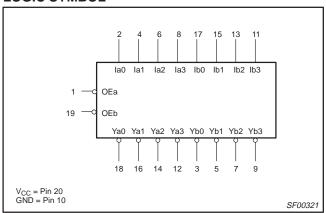
	ORDER CODE	
DESCRIPTION	COMMERCIAL RANGE $V_{CC}$ = 5V ±10%, $T_{amb}$ = 0°C to +70°C	DRAWING NUMBER
20-pin plastic DIP	74ALS240AN, 74ALS240A-1N	SOT146-1
20-pin plastic SOL	74ALS240AD, 74ALS240A-1D	SOT163-1
20-pin plastic SSOP Type II	74ALS240ADB, 74ALS240A-1DB	SOT339-1

#### INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

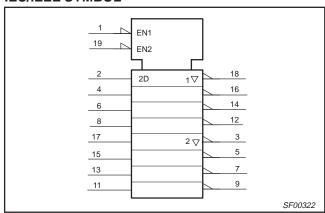
PINS	DESCRIPTION	74ALS (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
lan, Ibn	Data inputs	1.0/1.0	20μA/0.1mA
ŌĒa, ŌĒb	Output Enable inputs (active-Low)	1.0/1.0	20μA/0.1mA
₹an, ₹bn	Data outputs	750/240	15mA/24mA
₹an, ₹bn	Data outputs (-1 version)	750/480	15mA/48mA

**NOTE:** One (1.0) ALS unit load is defined as: 20μA in the High state and 0.1mA in the Low state.

#### LOGIC SYMBOL



#### **IEC/IEEE SYMBOL**

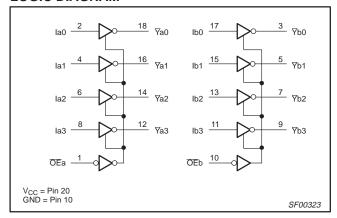


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#### **LOGIC DIAGRAM**



#### **FUNCTION TABLE**

	INP	OUTF	PUTS		
<u>OE</u> a	la	<del>OE</del> b	lb	₹a	₹b
L	L	L	L	Н	Н
L	Н	L	Н	L	L
Н	Х	Н	Х	Z	Z

High voltage level Low voltage level

X = Don't care Z = High impedance "off" state

#### **ABSOLUTE MAXIMUM RATINGS**

(Operation beyond the limit set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free air temperature range.)

SYMBOL	PARAMETER	RATING	UNIT	
V <sub>CC</sub>	Supply voltage		−0.5 to +7.0	V
V <sub>IN</sub>	Input voltage		−0.5 to +7.0	V
I <sub>IN</sub>	Input current		-30 to +5	mA
V <sub>OUT</sub>	Voltage applied to output in High output state		−0.5 to V <sub>CC</sub>	V
,	Current applied to output in Law output state	All versions	48	mA
lout	Current applied to output in Low output state	-1 version	96	mA
T <sub>amb</sub>	Operating free-air temperature range	0 to +70	°C	
T <sub>stg</sub>	Storage temperature range		-65 to +150	°C

#### **RECOMMENDED OPERATING CONDITIONS**

SYMBOL	PARAMETER		UNIT			
STWIBUL			MIN	NOM	MAX	UNII
V <sub>CC</sub>	Supply voltage		4.5	5.0	5.5	V
V <sub>IH</sub>	High-level input voltage		2.0			V
V <sub>IL</sub>	Low-level input voltage			0.8	V	
I <sub>IK</sub>	Input clamp current				-18	mA
I <sub>OH</sub>	High-level output current				-15	mA
	Low lovel output ourrent	All versions			24	mA
loL	Low-level output current			48 <sup>1</sup>	mA	
T <sub>amb</sub>	Operating free-air temperature range	0		+70	°C	

#### NOTE:

1. The 48mA limit applies only under the condition of  $V_{CC}$  = 5.0V ±5%.

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#### DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

CVMDOL	SYMBOL PARAMETER		PARAMETER TEST CONDITIONS <sup>1</sup>			LIMITS		UNIT
STMBOL	PARAMETER	ζ	TEST CONDITI	TEST CONDITIONS			MAX	UNII
			V <sub>CC</sub> ±10%, V <sub>IL</sub> = MAX,	$I_{OH} = -0.4$ mA	V <sub>CC</sub> – 2			V
V <sub>OH</sub>	High-level output voltage		V <sub>IH</sub> = MIN	$I_{OH} = -3mA$	2.4	3.2		V
On	3		$V_{CC} = MIN, V_{IL} = MAX, V_{IH} = MIN$	I <sub>OH</sub> = -15mA	2.0			
		All versions	$V_{CC} = MIN, V_{IL} = MAX,$	I <sub>OL</sub> = 12mA		0.25	0.40	V
V <sub>OL</sub>	Low-level output voltage	All versions	V <sub>IH</sub> = MIN	I <sub>OL</sub> = 24mA		0.35	0.50	V
OL.		-1 version	$V_{CC} = 4.75V$ , $V_{IL} = MAX$ , $V_{IH} = MIN$	I <sub>OL</sub> = 48mA		0.35	0.50	V
V <sub>IK</sub>	Input clamp voltage		$V_{CC} = MIN, I_I = I_{IK}$			-0.73	-1.5	V
lı	Input current at maximum	input voltage	$V_{CC} = MAX, V_I = 7.0V$				0.1	mA
I <sub>IH</sub>	High-level input current		$V_{CC} = MAX, V_I = 2.7V$				20	μΑ
I <sub>IL</sub>	Low-level input current		$V_{CC} = MAX, V_I = 0.4V$				-0.1	mA
I <sub>OZH</sub>	Off-state output current, High-level voltage applied						20	μΑ
I <sub>OZL</sub>	Off-state output current, Low-level voltage applied		$V_{CC} = MAX, V_I = 0.4V$				-20	μΑ
I <sub>O</sub>	Output current <sup>3</sup>		$V_{CC} = MAX, V_O = 2.25V$		-30		-112	mA
		Іссн				2.5	11	mA
I <sub>CC</sub>	Supply current (total)	I <sub>CCL</sub>	$V_{CC} = MAX$			19.5	23	mA
		I <sub>CCZ</sub>				23	30	

#### NOTES:

- 1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
- All typical values are at V<sub>CC</sub> = 5V, T<sub>amb</sub> = 25°C.
  The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I<sub>OS</sub>.

#### **AC ELECTRICAL CHARACTERISTICS**

			LIM	ITS	
SYMBOL	PARAMETER	TEST CONDITION	T <sub>amb</sub> = 0°C V <sub>CC</sub> = +5. C <sub>L</sub> = 50pF,	UNIT	
			MIN	MAX	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay In to Yn	Waveform 1	2.0 2.0	9.0 9.0	ns
t <sub>PZH</sub> t <sub>PZL</sub>	Output Enable time to High or Low level	Waveform 2 Waveform 3	2.0 3.0	10.0 12.0	ns
t <sub>PHZ</sub> t <sub>PLZ</sub>	Output disable time from High or Low level	Waveform 2 Waveform 3	2.0 3.0	10.0 12.0	ns

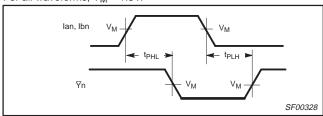
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## Octal inverter buffer (3-State)

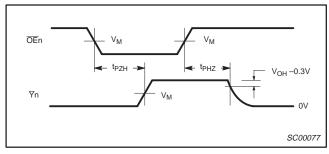
74ALS240A/ 74ALS240A-1

#### **AC WAVEFORMS**

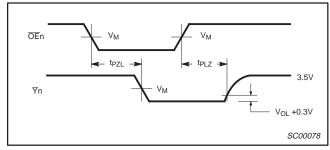
For all waveforms,  $V_M = 1.3V$ .



Waveform 1. Propagation Delay for Non-Inverting Output

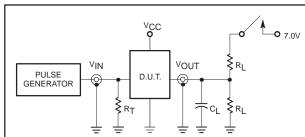


Waveform 2. 3-State Output Enable Time to High Level and Output Disable Time from High Level



Waveform 3. 3-State Output Enable Time to Low Level and Output Disable Time from Low Level

#### **TEST CIRCUIT AND WAVEFORMS**



**Test Circuit for 3-State Outputs** 

#### **SWITCH POSITION**

TEST	SWITCH
t <sub>PLZ</sub> , t <sub>PZL</sub>	closed
All other	open

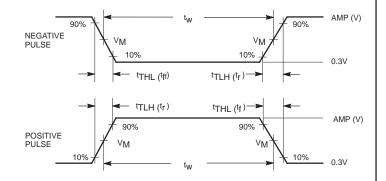
#### **DEFINITIONS:**

R<sub>L</sub> = Load resistor;

see AC electrical characteristics for value.

 $C_L = Load$  capacitance includes jig and probe capacitance; see AC electrical characteristics for value.

 $R_T$  = Termination resistance should be equal to  $Z_{OUT}$  of pulse generators.



#### **Input Pulse Definition**

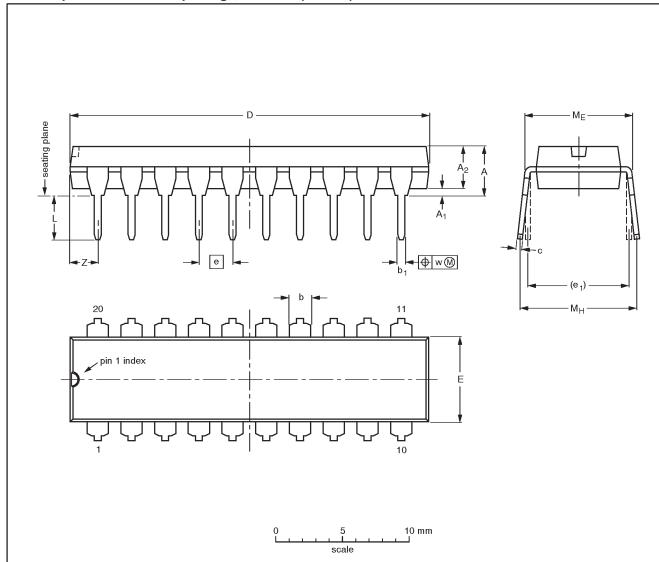
Family		INPUT	PULSE RE	QUIREN	MENTS	
	Amplitude	$V_{\text{M}}$	Rep.Rate	t <sub>w</sub>	t <sub>TLH</sub>	t <sub>THL</sub>
74ALS	3.5V	1.3V	1MHz	500ns	2.0ns	2.0ns

SC00072

## 74ALS240A/74ALS240A-1

#### DIP20: plastic dual in-line package; 20 leads (300 mil)

SOT146-1



#### DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	b	b <sub>1</sub>	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	e <sub>1</sub>	L	ME	Мн	w	Z <sup>(1)</sup> max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	0.36 0.23	26.92 26.54	6.40 6.22	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.0
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.014 0.009	1.060 1.045	0.25 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.078

#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

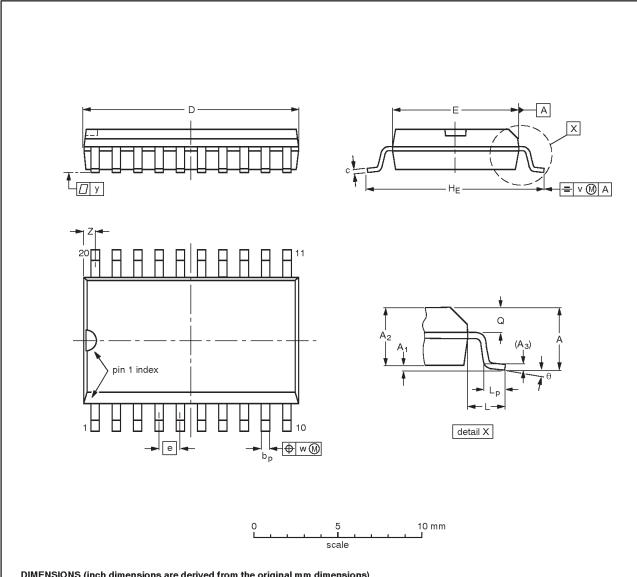
OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT146-1			SC603		<del>92-11-17</del> 95-05-24

1991 Feb 08 6

## 74ALS240A/74ALS240A-1

#### SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



#### DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	Α1	A <sub>2</sub>	A <sub>3</sub>	bp	O	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	ø	٧	w	у	z <sup>(1)</sup>	θ
mm	2.65	0.30 0.10	2.45 2.25	0.25	0.49 0.36	0.32 0.23	13.0 12.6	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8°
inches	0.10	0.012 0.004	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.51 0.49	0.30 0.29	0.050	0.42 0.39	0.055	0.043 0.016	0.043 0.039	0.01	0.01	0.004	0.035 0.016	0°

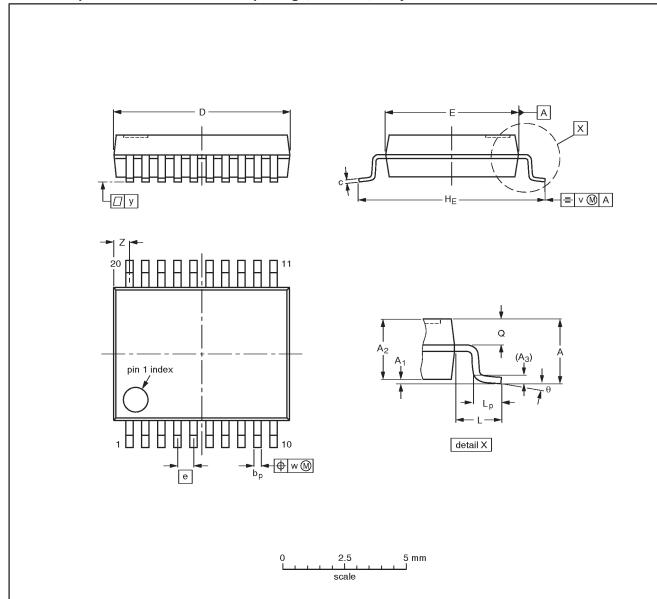
1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ	PROJECTION	1930E DATE	
SOT163-1	075E04	MS-013AC			<del>-92-11-17</del> 95-01-24	

## 74ALS240A/74ALS240A-1

#### SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1



#### DIMENSIONS (mm are the original dimensions)

UNIT	A max.	Α1	A <sub>2</sub>	А3	р <sub>р</sub>	O	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	٦	Lp	Ø	v	w	у	Z <sup>(1)</sup>	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	7.4 7.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	0.9 0.5	8° 0°

#### Note

1. Plastic or metal protrusions of 0.20 mm maximum per side are not included.

OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ	PROJECTION	1990E DATE	
SOT339-1		MO-150AE			<del>93-09-08</del> 95-02-04	

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## Octal inverter buffer (3-State)

#### 74ALS240A/74ALS240A-1

	DEFINITIONS							
Data Sheet Identification	Product Status	Definition						
Objective Specification	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.						
Preliminary Specification	Preproduction Product	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.						
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